Dual Buffer with 3-State Outputs

The NL27WZ125 is a high performance dual noninverting buffer operating from a 1.65 V to 5.5 V supply.

Features

- Extremely High Speed: t_{PD} 2.6 ns (typical) at $V_{CC} = 5 V$
- $\bullet\,$ Designed for 1.65 V to 5.5 V V_{CC} Operation
- Over Voltage Tolerant Inputs and Outputs
- LVTTL Compatible Interface Capability With 5 V TTL Logic with V_{CC} = 3 V
- LVCMOS Compatible
- 24 mA Balanced Output Sink and Source Capability
- Near Zero Static Supply Current Substantially Reduces System Power Requirements
- 3–State OE Input is Active–Low
- Replacement for NC7WZ125
- Chip Complexity = 72 FETs
- Pb–Free Package is Available

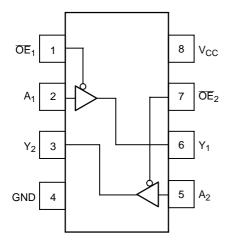
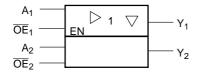


Figure 1. Pinout (Top View)

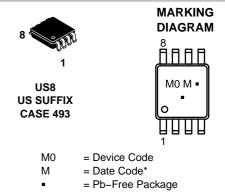






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(Note: Microdot may be in either location)

*Date Code orientation may vary depending upon manufacturing location.

PIN ASSIGNMENT

Pin	Function
1	OE ₁
2	A ₁
3	Y ₂
4	GND
5	A ₂
6	Y ₁
7	OE ₂
8	V _{CC}

FUNCTION TABLE

Input		
A _n	Y _n	
L	L	
Н	Н	
Х	Z	
	A _n L	

X = Don't Care

n = 1, 2

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

DEVICE ORDERING INFORMATION

		Device Nomenclature							
Device Order Number	Logic Circuit Indicator	No. of Gates per Package	Temp Range Identifier	Technology	Device Function	Package Suffix	Package Type	Tape and Reel Size [†]	
NL27WZ125US	NL	2	7	WZ	125	US	US8	178 mm, 3000 Unit	
NL27WZ125USG	NL	2	7	WZ	125	US	US8 (Pb–Free)	178 mm, 3000 Unit	

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MAXIMUM RATINGS

Symbol	Parameter		Value	Unit
V _{CC}	DC Supply Voltage		-0.5 to +7.0	V
VI	DC Input Voltage		-0.5 to +7.0	V
V _O		in High Impedance State out in HIGH or LOW State	-0.5 to +7.0 -0.5 to V _{CC} + 0.5	V
I _{IK}	DC Input Diode Current	V _I < GND	-50	mA
I _{OK}	DC Output Diode Current	V _O < GND	-50	mA
Ι _Ο	DC Output Sink Current		± 50	mA
I _{CC}	DC Supply Current per Supply Pin		±100	mA
I _{GND}	DC Ground Current per Ground Pin		±100	mA
T _{STG}	Storage Temperature Range		-65 to +150	°C
ΤL	Lead Temperature, 1 mm from Case for 10 Seconds		260	°C
TJ	Junction Temperature under Bias		+ 150	°C
θ_{JA}	Thermal Resistance	(Note 1)	250	°C/W
PD	Power Dissipation in Still Air at 85°C		250	mW
MSL	Moisture Sensitivity		Level 1	
F _R	Flammability Rating	Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in	
V _{ESD}	, , , , , , , , , , , , , , , , , , ,	man Body Model (Note 2) Machine Model (Note 3) ed Device Model (Note 4)	> 2000 > 200 N/A	V

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.
Measured with minimum pad spacing on an FR4 board, using 10 mm-by-1 inch, 2-ounce copper trace with no air flow.
Tested to EIA/JESD22-A114-A.

3. Tested to EIA/JESD22-A115-A.

4. Tested to JESD22-C101-A.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit	
V _{CC}	Supply Voltage	1.65 1.5	5.5 5.5	V	
VI	Input Voltage	(Note 5)	0	5.5	V
Vo	Output Voltage	(HIGH or LOW State)	0	5.5	V
T _A	Operating Free–Air Temperature		-40	+ 85	°C
$\Delta t / \Delta V$	Input Transition Rise or Fall Rate	$V_{CC} = 2.5 V \pm 0.2 V V_{CC} = 3.0 V \pm 0.3 V V_{CC} = 5.0 V \pm 0.5 V$	0 0 0	20 10 5	ns/V

5. Unused inputs may not be left open. All inputs must be tied to a high- or low-logic input voltage level.

DC ELECTRICAL CHARACTERISTICS

	Parameter	Condition	V _{CC} (V)	T _A = 25°C			$-40^{\circ}C \leq$		
Symbol				Min	Тур	Max	Min	Max	Unit
V _{IH}	High-Level Input Voltage		1.65 2.3 to 5.5	0.75 V _{CC} 0.7 V _{CC}			0.75 V _{CC} 0.7 V _{CC}		V
V _{IL}	Low-Level Input Voltage		1.65 2.3 to 5.5			0.25 V _{CC} 0.3 V _{CC}		0.25 V _{CC} 0.3 V _{CC}	V
V _{OH}	High–Level Output Voltage $V_{IN} = V_{IL}$ or V_{IH}	$\begin{split} I_{OH} &= 100 \ \mu A \\ I_{OH} &= -3 \ m A \\ I_{OH} &= -8 \ m A \\ I_{OH} &= -12 \ m A \\ I_{OH} &= -16 \ m A \\ I_{OH} &= -24 \ m A \\ I_{OH} &= -32 \ m A \end{split}$	1.65 to 5.5 1.65 2.3 2.7 3.0 3.0 4.5	$\begin{array}{c} V_{CC} - 0.1 \\ 1.29 \\ 1.9 \\ 2.2 \\ 2.4 \\ 2.3 \\ 3.8 \end{array}$	V _{CC} 1.52 2.1 2.4 2.7 2.5 4.0		V _{CC} -0.1 1.29 1.9 2.2 2.4 2.3 3.8		V
V _{OL}	Low–Level Output Voltage V _{IN} = V _{IL}	$\begin{split} I_{OL} &= 100 \; \mu A \\ I_{OL} &= 3 \; m A \\ I_{OL} &= 8 \; m A \\ I_{OL} &= 12 \; m A \\ I_{OL} &= 16 \; m A \\ I_{OL} &= 24 \; m A \\ I_{OL} &= 32 \; m A \end{split}$	1.65 to 5.5 2.3 2.7 3.0 3.0 4.5		0.08 0.20 0.22 0.28 0.38 0.42	0.1 0.24 0.3 0.4 0.4 0.55 0.55		0.1 0.24 0.3 0.4 0.4 0.55 0.55	V
I _{IN}	Input Leakage Current	$V_{IN} = V_{CC}$ or GND	5.5			±0.1		±1.0	μΑ
I _{OFF}	Power Off Leakage Current	V _{OUT} = 5.5 V V _{IN} = 5.5 V	0			1.0		10	μΑ
I _{CC}	Quiescent Supply Current	$V_{IN} = V_{CC}$ or GND	5.5			1.0		10	μΑ
I _{OZ}	3-State Output Leakage	$\begin{array}{l} V_{\text{IN}} = V_{\text{IL}} \text{ or } V_{\text{IH}} \\ 0V \leq V_{\text{OUT}} \leq 5.5 \; V \end{array}$	2.3 to 5.5			±0.5		±5	μΑ

AC ELECTRICAL CHARACTERISTICS (t_R = t_F = 3.0 ns)

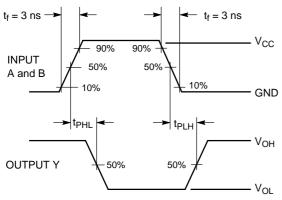
			V _{CC}	Т	_A = 25°	С	−40°C ≤	$T_A \leq 85^{\circ}C$		
Symbol	Parameter	Cond	ition	(V)	Min	Тур	Max	Min	Max	Unit
t _{PLH} t _{PHL}	Propagation Delay AN to YN	$R_L = 1 M\Omega$	C _L = 15 pF	$\begin{array}{c} 1.8 \pm 0.15 \\ 2.5 \pm 0.2 \end{array}$	2.0 1.0		12 7.5	2.0 1.0	13 8	ns
	(Figures 3 and 4)	$R_L = 1 M\Omega$	C _L = 15 pF	3.3 ± 0.3	0.8		5.2	0.8	5.5	1
		R_L = 500 Ω	C _L = 50 pF		1.2		5.7	1.2	6.0	
		$R_L = 1 M\Omega$	C _L = 15 pF	5.0 ± 0.5	0.5		4.5	0.5	4.8	
		R_L = 500 Ω	C _L = 50 pF		0.8		5.0	0.8	5.3	
	Output to Output Skew	R_L = 500 Ω	C _L = 50 pF	3.3 ± 0.3			1.0		1.0	ns
	(Note 6)	R_L = 500 Ω	C _L = 50 pF	5.0 ± 0.5			0.8		0.8	
t _{PZH} t _{PZL}	Output Enable Time (Figures 5, 6 and 7)			$\begin{array}{c} 1.8 \pm 0.15 \\ 2.5 \pm 0.2 \end{array}$	3.0 1.8		14 8.5	3.0 1.8	15 9.0	ns
				3.3 ± 0.3	1.2		6.2	1.2	6.5	
				5.0 ± 0.5	0.8		5.5	0.8	5.8	
t _{PHZ} t _{PLZ}	Output Enable Time (Figures 5, 6 and 7)			$\begin{array}{c} 1.8 \pm 0.15 \\ 2.5 \pm 0.2 \end{array}$	2.5 1.5		12 8.0	2.5 1.5	13 8.5	ns
				3.3 ± 0.3	0.8		5.7	0.8	6.0	1
				5.0 ± 0.5	0.3		4.7	0.3	5.0	1

6. Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. This specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t_{OSHL}) or LOW-to-HIGH (t_{OSLH}); parameter guaranteed by design.

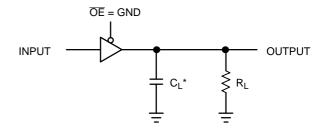
CAPACITIVE CHARACTERISTICS

Symbol	Parameter	Condition	Typical	Unit
C _{IN}	Input Capacitance	V_{CC} = 5.5 V, V_{I} = 0 V or V_{CC}	7.0	pF
C _{OUT}	Output Capacitance	V_{CC} = 5.5 V, V_{I} = 0 V or V_{CC}	7.0	pF
C _{PD}	Power Dissipation Capacitance (Note 7)	10 MHz, V_{CC} = 3.3 V, V_{I} = 0 V or V_{CC} 10 MHz, V_{CC} = 5.5 V, V_{I} = 0 V or V_{CC}	18 27	pF

7. C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: I_{CC(OPR)} = C_{PD} • V_{CC} • f_{in} + I_{CC}. C_{PD} is used to determine the no–load dynamic power consumption; P_D = C_{PD} • V_{CC}² • f_{in} + I_{CC} • V_{CC}.







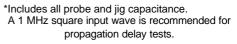
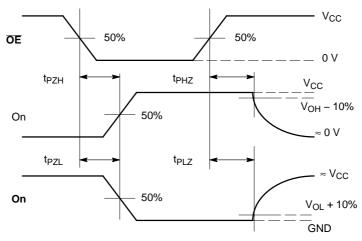
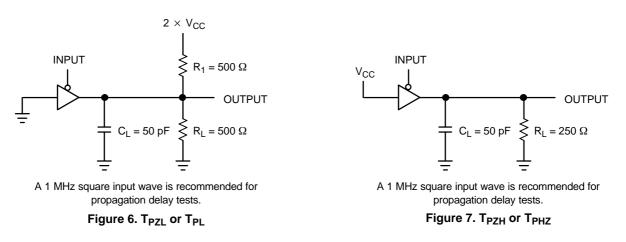


Figure 4. T_{PLH} or T_{PHL}

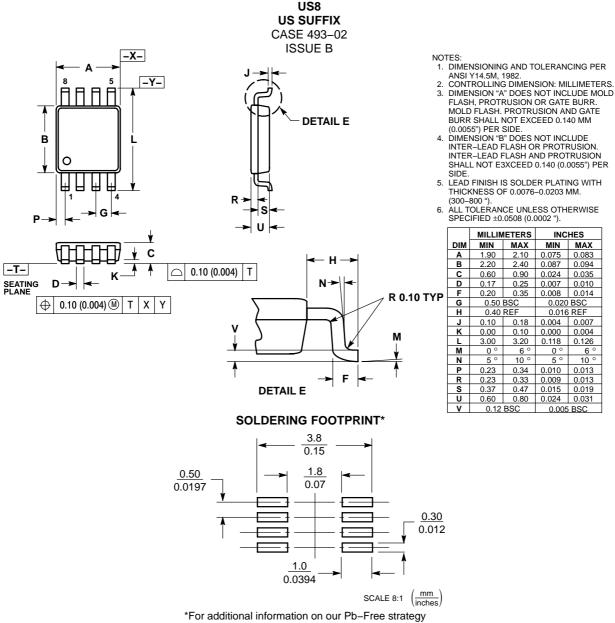








PACKAGE DIMENSIONS



and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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